

Crystal LTD TM SPEC Form

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Customer

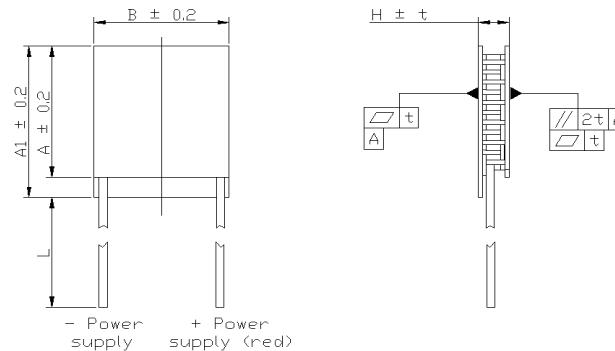
PO#

PO date

Thermoelectric module (TM) specification

PO position #	TM	Internal Solder Melting Temp, C	Max operating temperature, °C		Parameters in vacuum at hot side temperature 25 °C				Rac at 25 °C		Ceramic size, mm		TM Height		Wire			Sealing
			short time	long time	Imax, A	Umax, V	Qmax, W	dTmax, K	Rac, Ohm	Tolerance ±, %	A/A1	B	Height, mm	Tolerance t, ± mm	S, AWG #	Length, mm	Tolerance ±, mm	
1	S-031-05-20	138	130	115	0.6	3.9	1.4	75.5	5.21	10	8/8	8	3.40	0.2	30	100	5	
															solid tinned uninsulated			

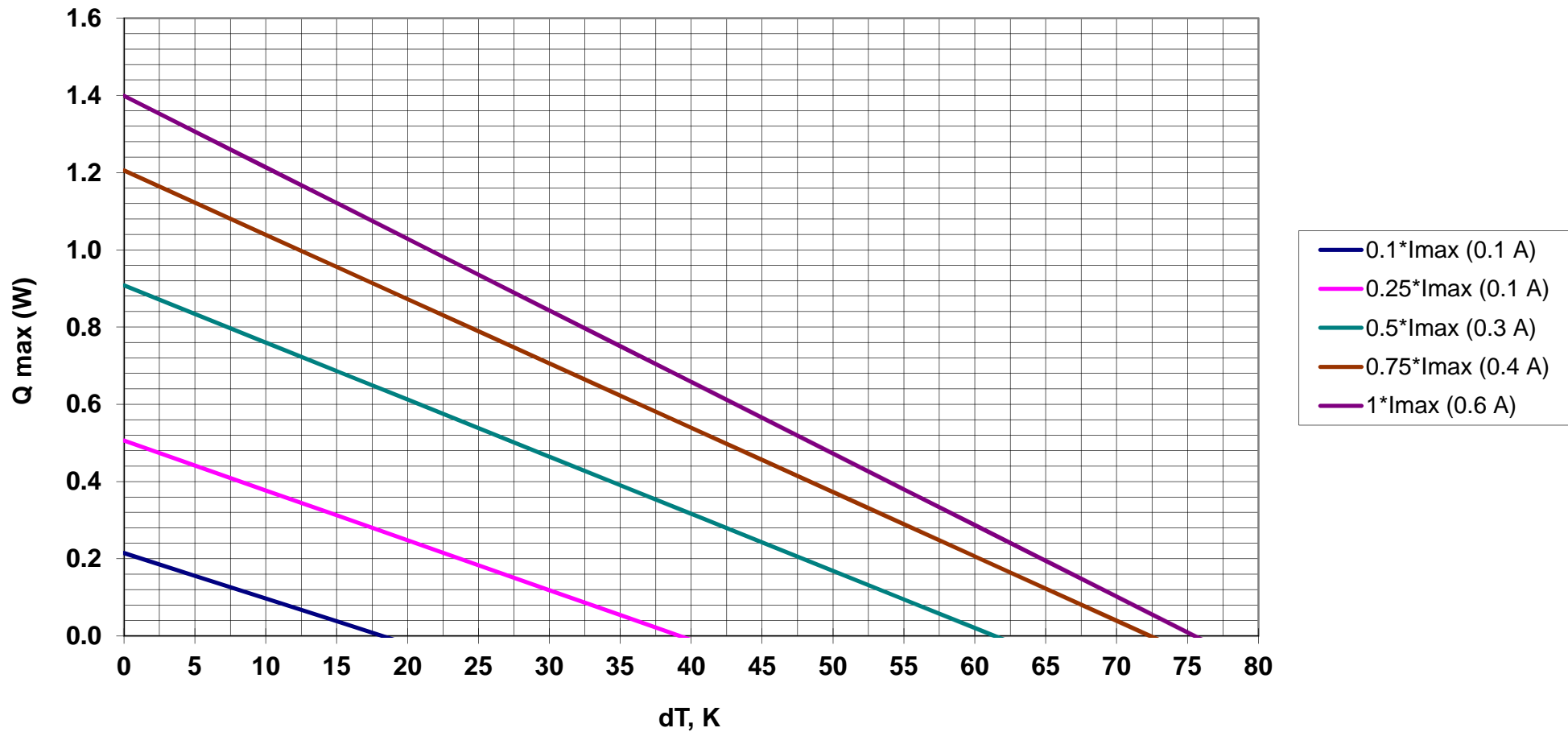
Clamping force: 0.9 - 1.9 kg



Max dT is reduced by 2-3K for silicon sealed and 1-2K for epoxy sealed versions.

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Q(dT) at $T_{hot}=298K$



U(dT) at Thot=298K

